



# Product Change Notification

## 111511 - 04

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**Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.**

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# Product Change Notification

**Change Notification #:** 111511 - 04  
**Change Title:** Intel® Desktop Board DZ77BH-55K, Boxed and Bulk  
PCN 111511-04, Product Design  
PCB Fab Update  
**Reason for Revision: The PCB Change has not yet implemented and an update will be provided at a future date.**  
**Date of Publication:** February 19, 2013

## Key Characteristics of the Change:

Product Design

## Forecasted Key Milestones:

<b>Date Customer Must be Ready to Receive Post-Conversion Material:</b>	<b>TBD</b>
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## Description of Change to the Customer:

**Reason for Revision: The PCB Change has not yet implemented and an update will be provided at a future date.**

The printed circuit board for DZ77BH55K will be updated to include a resistor foot print at reference designator location R461. It is to prevent false over current error on the Front Panel USB 3.0 header.

## Customer Impact of Change and Recommended Action:

This change has been evaluated to ensure that there is no quality, reliability, or functional implication to our customers. Intel is not recommending additional qualification of these changes on platforms received from Intel.

Intel will attempt to deplete pre-conversion material before shipping post-conversion material but there is a possibility of Intel shipping mixed inventory. Therefore, customers will need to manage and migrate to the post-conversion material as soon as possible.

Milestone dates are estimates and subject to change based on business and operational conditions.

**Products Affected / Intel Ordering Codes:**

Product Code	MM#	Pre Change AA	Post Change AA
BOXDZ77BH55K	920771	G39008-400	G39008-500
BLKDZ77BH55K	920772	G39008-400	G39008-500

**PCN Revision History:**

<b>Date of Revision:</b>	<b>Revision Number:</b>	<b>Reason:</b>
May 22, 2012	00	Originally Published PCN
September 28, 2012	01	Implementation Date Change
December 6, 2012	02	Implementation Date Change
December 26, 2012	03	Implementation Date Change
February 19, 2013	04	The PCB Change has not yet implemented and an update will be provided at a future date.